

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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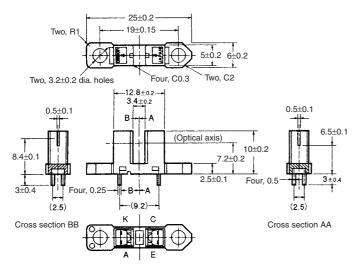
Photomicrosensor (Transmissive) **FF-SX1088**



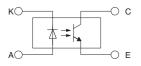
Be sure to read Precautions on page 25.

■ Dimensions

Note: All units are in millimeters unless otherwise indicated.



Internal Circuit



| Terminal No. | Name | |
|--------------|-----------|--|
| Α | Anode | |
| K | Cathode | |
| С | Collector | |
| E | Emitter | |

Unless otherwise specified, the tolerances are as shown below.

| Dimensions | Tolerance |
|--------------|-----------|
| 3 mm max. | ±0.3 |
| 3 < mm ≤ 6 | ±0.375 |
| 6 < mm ≤ 10 | ±0.45 |
| 10 < mm ≤ 18 | ±0.55 |
| 18 < mm ≤ 30 | ±0.65 |

■ Features

- General-purpose model with a 3.4-mm-wide slot.
- Mounts to PCBs or connects to connectors.
- High resolution with a 0.5-mm-wide aperture.
- OMRON's XK8-series Connectors can be connected without soldering. Contact your OMRON representative for information on obtaining XK8-series Connectors.

■ Absolute Maximum Ratings (Ta = 25°C)

| | Item | Symbol | Rated value |
|-----------------------|----------------------------|------------------|------------------------|
| Emitter | Forward current | I _F | 50 mA (see note 1) |
| | Pulse forward cur- rent | I _{FP} | 1 A (see note 2) |
| | Reverse voltage | V_R | 4 V |
| Detector | Collector-Emitter voltage | V _{CEO} | 30 V |
| | Emitter-Collector voltage | V _{ECO} | |
| | Collector current | I _C | 20 mA |
| | Collector dissipation | P _C | 100 mW (see note 1) |
| Ambient tem- | Operating | Topr | –25°C to 85°C |
| perature | Storage | Tstg | –30°C to 100°C |
| Soldering temperature | | Tsol | 260°C (see note 3) |

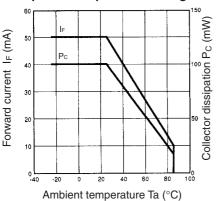
- Note: 1. Refer to the temperature rating chart if the ambient temperature exceeds 25° C.
 - 2. The pulse width is 10 μs maximum with a frequency of 100 Hz.
 - 3. Complete soldering within 10 seconds.

■ Electrical and Optical Characteristics (Ta = 25°C)

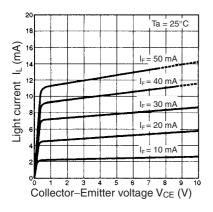
| Item | | Symbol | Value | Condition |
|--------------|---|-----------------------|--------------------------|--|
| Emitter | Forward voltage | V_{F} | 1.2 V typ., 1.5 V max. | I _F = 30 mA |
| | Reverse current | I _R | 0.01 μA typ., 10 μA max. | V _R = 4 V |
| | Peak emission wavelength | λ_{P} | 940 nm typ. | I _F = 20 mA |
| Detector | Light current | IL | 0.5 mA min., 14 mA max. | I _F = 20 mA, V _{CE} = 10 V |
| | Dark current | I _D | 2 nA typ., 200 nA max. | V _{CE} = 10 V, 0 ℓx |
| | Leakage current | I _{LEAK} | | |
| | Collector–Emitter saturated voltage | V _{CE} (sat) | 0.15 V typ., 0.4 V max. | I _F = 20 mA, I _L = 0.1 mA |
| | Peak spectral sensitivity wave- length | λ_{P} | 850 nm typ. | V _{CE} = 10 V |
| Rising time | | tr | 4 μs typ. | $V_{CC} = 5 \text{ V}, R_L = 100 \Omega, I_L = 5 \text{ mA}$ |
| Falling time | 1 | tf | 4 μs typ. | $V_{CC} = 5 \text{ V}, R_{L} = 100 \Omega, I_{L} = 5 \text{ mA}$ |

■ Engineering Data

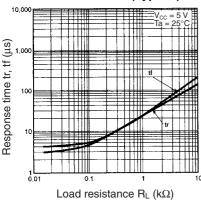
Forward Current vs. Collector Dissipation Temperature Rating



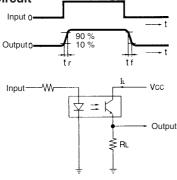
Light Current vs. Collector–Emitter Voltage Characteristics (Typical)



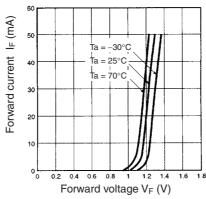
Response Time vs. Load Resistance Characteristics (Typical)



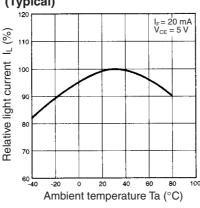
Response Time Measurement Circuit



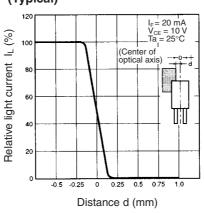
Forward Current vs. Forward Voltage Characteristics (Typical)



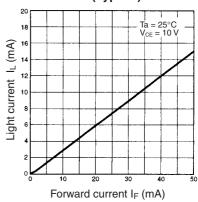
Relative Light Current vs. Ambient Temperature Characteristics (Typical)



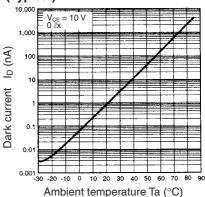
Sensing Position Characteristics (Typical)



Light Current vs. Forward Current Characteristics (Typical)



Dark Current vs. Ambient Temperature Characteristics (Typical)



Sensing Position Characteristics (Typical)

